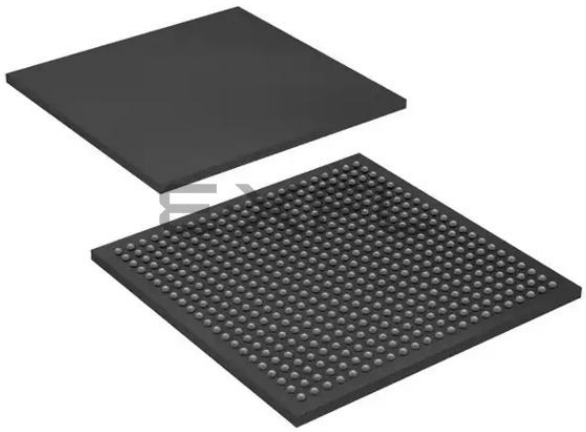

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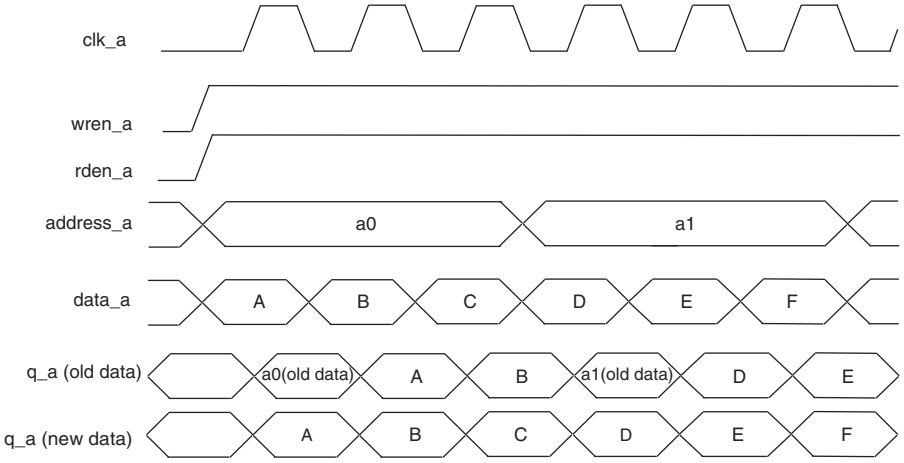
Details	
Product Status	Active
Number of LABs/CLBs	2475
Number of Logic Elements/Cells	39600
Total RAM Bits	1161216
Number of I/O	328
Number of Gates	-
Voltage - Supply	0.97V ~ 1.03V
Mounting Type	Surface Mount
Operating Temperature	0°C ~ 85°C (TJ)
Package / Case	484-BGA
Supplier Device Package	484-FBGA (23x23)
Purchase URL	https://www.e-xfl.com/product-detail/intel/ep4ce40f23c8l

Figure 3–7 shows a timing waveform for read and write operations in single-port mode with unregistered outputs. Registering the outputs of the RAM simply delays the q output by one clock cycle.

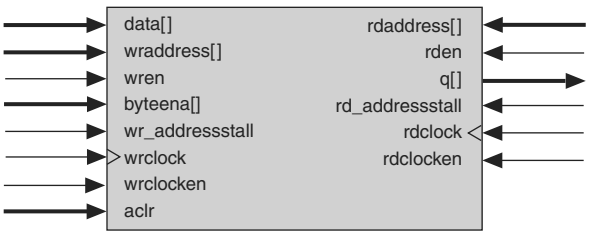
Figure 3–7. Cyclone IV Devices Single-Port Mode Timing Waveform



Simple Dual-Port Mode

Simple dual-port mode supports simultaneous read and write operations to different locations. Figure 3–8 shows the simple dual-port memory configuration.

Figure 3–8. Cyclone IV Devices Simple Dual-Port Memory *(1)*



Note to Figure 3–8:

(1) Simple dual-port RAM supports input or output clock mode in addition to the read or write clock mode shown.

Cyclone IV devices M9K memory blocks support mixed-width configurations, allowing different read and write port widths. Table 3–3 lists mixed-width configurations.

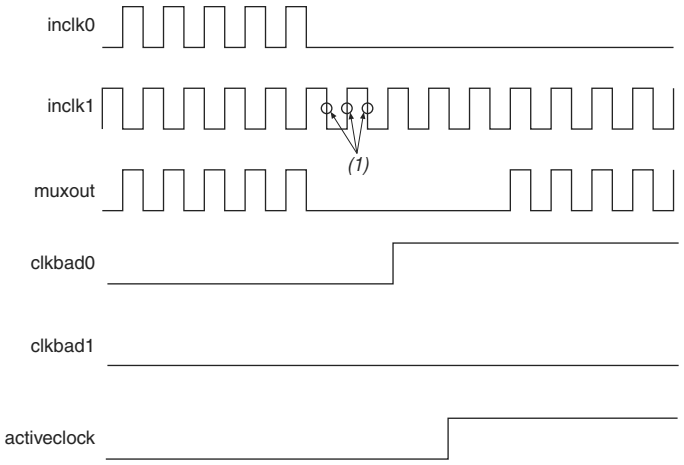
Table 3–3. Cyclone IV Devices M9K Block Mixed-Width Configurations (Simple Dual-Port Mode) ***(Part 1 of 2)***

Read Port	Write Port								
	8192 × 1	4096 × 2	2048 × 4	1024 × 8	512 × 16	256 × 32	1024 × 9	512 × 18	256 × 36
8192 × 1	✓	✓	✓	✓	✓	✓	—	—	—
4096 × 2	✓	✓	✓	✓	✓	✓	—	—	—
2048 × 4	✓	✓	✓	✓	✓	✓	—	—	—
1024 × 8	✓	✓	✓	✓	✓	✓	—	—	—

20%. This feature is useful when clock sources can originate from multiple cards on the backplane, requiring a system-controlled switchover between frequencies of operation. Choose the secondary clock frequency so the VCO operates in the recommended frequency range. Also, set the M, N, and C counters accordingly to keep the VCO operating frequency in the recommended range.

Figure 5–18 shows a waveform example of the switchover feature when using automatic loss of clock detection. Here, the `inclk0` signal remains low. After the `inclk0` signal remains low for approximately two clock cycles, the clock-sense circuitry drives the `clkbad0` signal high. Also, because the reference clock signal is not toggling, the switchover state machine controls the multiplexer through the `clksw` signal to switch to `inclk1`.

Figure 5–18. Automatic Switchover Upon Clock Loss Detection *(1)*



Note to Figure 5–18:

(1) Switchover is enabled on the falling edge of `inclk0` or `inclk1`, depending on which clock is available. In this figure, switchover is enabled on the falling edge of `inclk1`.

Manual Override

If you are using the automatic switchover, you must switch input clocks with the manual override feature with the `clkswitch` input.

Figure 5–19 shows an example of a waveform illustrating the switchover feature when controlled by `clkswitch`. In this case, both clock sources are functional and `inclk0` is selected as the reference clock. A low-to-high transition of the `clkswitch` signal starts the switchover sequence. The `clkswitch` signal must be high for at least three clock cycles (at least three of the longer clock period if `inclk0` and `inclk1` have different frequencies). On the falling edge of `inclk0`, the reference clock of the counter, `muxout`, is gated off to prevent any clock glitching. On the falling edge of `inclk1`, the reference clock multiplexer switches from `inclk0` to `inclk1` as the PLL reference, and the `activeclock` signal changes to indicate which clock is currently feeding the PLL.

Differential I/O Standard Termination

Differential I/O standards typically require a termination resistor between the two signals at the receiver. The termination resistor must match the differential load impedance of the bus (refer to Figure 6–7 and Figure 6–8).

Cyclone IV devices support differential SSTL-2 and SSTL-18, differential HSTL-18, HSTL-15, and HSTL-12, PPDS, LVDS, RSDS, mini-LVDS, and differential LVPECL.

Figure 6–7. Cyclone IV Devices Differential HSTL I/O Standard Class I and Class II Interface and Termination

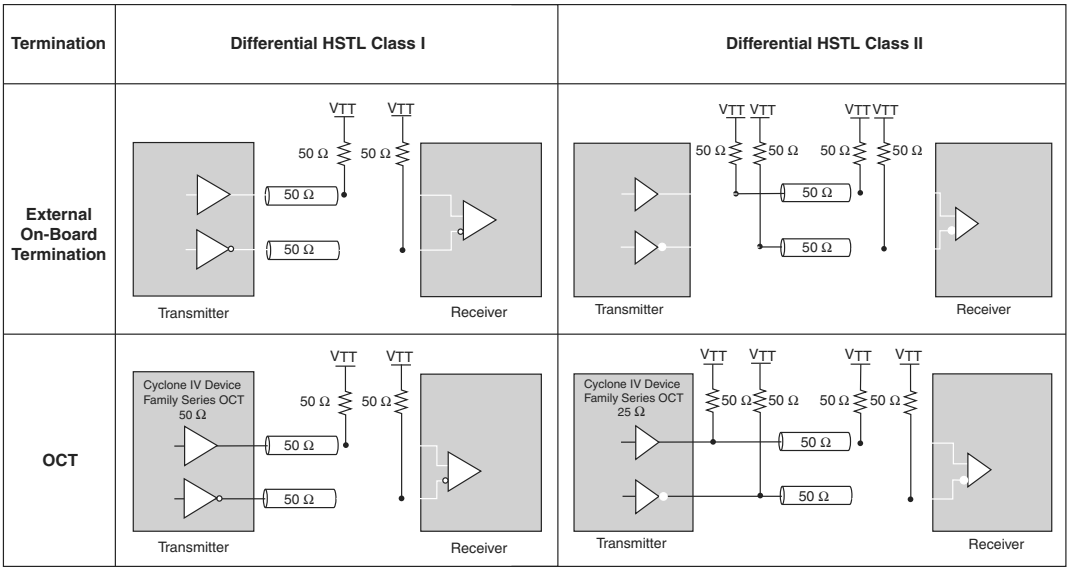
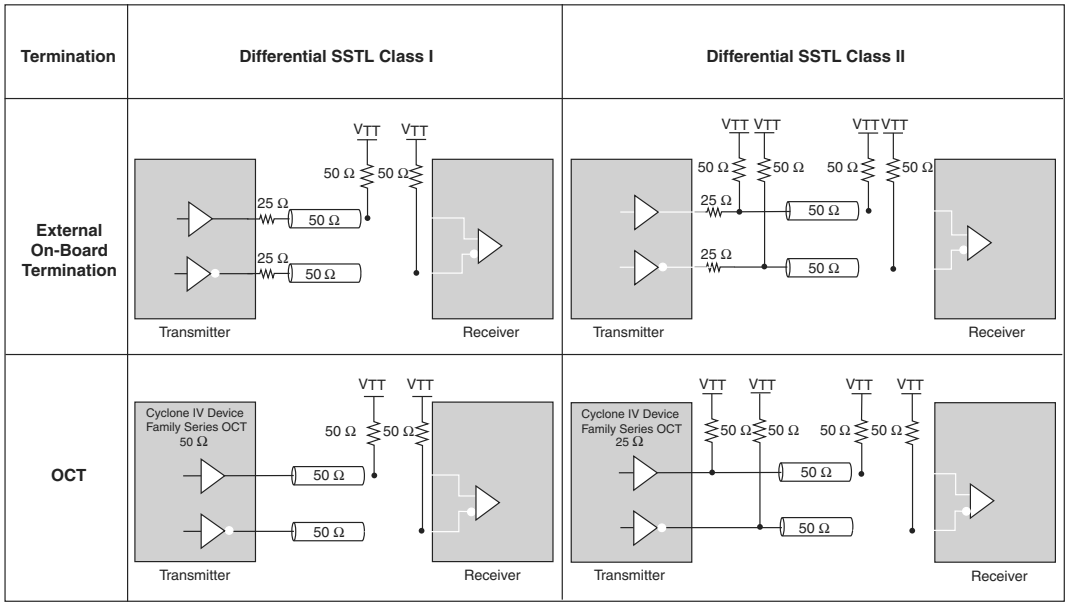


Figure 6–8. Cyclone IV Devices Differential SSTL I/O Standard Class I and Class II Interface and Termination *(1)*



Note to Figure 6–8:

(1) Only Differential SSTL-2 I/O standard supports Class II output.

Table 7–2 lists the number of DQS or DQ groups supported on each side of the Cyclone IV E device.

Table 7–2. Cyclone IV E Device DQS and DQ Bus Mode Support for Each Side of the Device (Part 1 of 3)

Device	Package	Side	Number ×8 Groups	Number ×9 Groups	Number ×16 Groups	Number ×18 Groups	Number ×32 Groups	Number ×36 Groups
EP4CE6 EP4CE10	144-pin EQFP	Left	0	0	0	0	—	—
		Right	0	0	0	0	—	—
		Bottom *(1), (3)*	1	0	0	0	—	—
		Top *(1), (4)*	1	0	0	0	—	—
	256-pin UBGA	Left *(1)*	1	1	0	0	—	—
		Right *(2)*	1	1	0	0	—	—
		Bottom	2	2	1	1	—	—
		Top	2	2	1	1	—	—
	256-pin FBGA	Left *(1)*	1	1	0	0	—	—
		Right *(2)*	1	1	0	0	—	—
		Bottom	2	2	1	1	—	—
		Top	2	2	1	1	—	—
EP4CE15	144-pin EQFP	Left	0	0	0	0	—	—
		Right	0	0	0	0	—	—
		Bottom *(1), (3)*	1	0	0	0	—	—
		Top *(1), (4)*	1	0	0	0	—	—
	164-pin MBGA	Left	0	0	0	0	—	—
		Right	0	0	0	0	—	—
		Bottom *(1), (3)*	1	0	0	0	—	—
		Top *(1), (4)*	1	0	0	0	—	—
	256-pin MBGA	Left	1	1	0	0	—	—
		Right	1	1	0	0	—	—
		Bottom *(1), (3)*	2	2	1	1	—	—
		Top *(1), (4)*	2	2	1	1	—	—
	256-pin UBGA	Left *(1)*	1	1	0	0	—	—
		Right *(2)*	1	1	0	0	—	—
		Bottom	2	2	1	1	—	—
		Top	2	2	1	1	—	—
	256-pin FBGA	Left *(1)*	1	1	0	0	—	—
		Right *(2)*	1	1	0	0	—	—
		Bottom	2	2	1	1	—	—
		Top	2	2	1	1	—	—
	484-pin FBGA	Left	4	4	2	2	1	1
		Right	4	4	2	2	1	1
		Bottom	4	4	2	2	1	1
		Top	4	4	2	2	1	1

The nSTATUS and CONF_DONE pins on all target devices are connected together with external pull-up resistors, as shown in Figure 8–8 on page 8–26 and Figure 8–9 on page 8–27. These pins are open-drain bidirectional pins on the devices. When the first device asserts nCEO (after receiving all its configuration data), it releases its CONF_DONE pin. However, the subsequent devices in the chain keep this shared CONF_DONE line low until they receive their configuration data. When all target devices in the chain receive their configuration data and release CONF_DONE, the pull-up resistor drives a high level on this line and all devices simultaneously enter initialization mode.

Guidelines for Connecting Parallel Flash to Cyclone IV E Devices for an AP Interface

For single- and multi-device AP configuration, the board trace length and loading between the supported parallel flash and Cyclone IV E devices must follow the recommendations listed in Table 8–11. These recommendations also apply to an AP configuration with multiple bus masters.

Table 8–11. Maximum Trace Length and Loading for AP Configuration

Cyclone IV E AP Pins	Maximum Board Trace Length from Cyclone IV E Device to Flash Device (inches)	Maximum Board Load (pF)
DCLK	6	15
DATA[15..0]	6	30
PADD[23..0]	6	30
nRESET	6	30
Flash_nCE	6	30
nOE	6	30
nAVD	6	30
nWE	6	30
I/O (1)	6	30

Note to Table 8–11:

(1) The AP configuration ignores the WAIT signal from the flash during configuration mode. However, if you are accessing flash during user mode with user logic, you can optionally use the normal I/O to monitor the WAIT signal from the Micron P30 or P33 flash.

Configuring With Multiple Bus Masters

Similar to the AS configuration scheme, the AP configuration scheme supports multiple bus masters for the parallel flash. For another master to take control of the AP configuration bus, the master must assert nCONFIG low for at least 500 ns to reset the master Cyclone IV E device and override the weak 10-kΩ pull-down resistor on the nCE pin. This resets the master Cyclone IV E device and causes it to tri-state its AP configuration bus. The other master device then takes control of the AP configuration bus. After the other master device is done, it releases the AP configuration bus, then releases the nCE pin, and finally pulses nCONFIG low to restart the configuration.

In the AP configuration scheme, multiple masters share the parallel flash. Similar to the AS configuration scheme, the bus control is negotiated by the nCE pin.

Table 8–19. Configuration Pin Summary for Cyclone IV E Devices (Part 2 of 3)

Bank	Description	Input/Output	Dedicated	Powered By	Configuration Mode
1	DATA[0] *(1), (2)*	Input	—	V_{CCIO}	PS, FPP, AS
		Bidirectional		V_{CCIO}	AP
1	DATA[1] *(2)*/ASDO *(1)*	Input	—	V_{CCIO}	FPP
		Output		V_{CCIO}	AS
		Bidirectional		V_{CCIO}	AP
8	DATA[7..2] *(2)*	Input	—	V_{CCIO}	FPP
		Bidirectional		V_{CCIO}	AP
8	DATA[15..8] *(2)*	Bidirectional	—	V_{CCIO}	AP
6	INIT_DONE	Output	—	Pull-up	Optional, all modes
1	nSTATUS	Bidirectional	Yes	Pull-up	All modes
1	nCE	Input	Yes	V_{CCIO}	All modes
1	DCLK *(1), (2)*	Input	Yes	V_{CCIO}	PS, FPP
		Output	—	V_{CCIO}	AS, AP
6	CONF_DONE	Bidirectional	Yes	Pull-up	All modes
1	TDI	Input	Yes	V_{CCIO}	JTAG
1	TMS	Input	Yes	V_{CCIO}	JTAG
1	TCK	Input	Yes	V_{CCIO}	JTAG
1	nCONFIG	Input	Yes	V_{CCIO}	All modes
6	CLKUSR	Input	—	V_{CCIO}	Optional
6	nCEO	Output	—	V_{CCIO}	Optional, all modes
6	MSEL[]	Input	Yes	V_{CCINT}	All modes
1	TDO	Output	Yes	V_{CCIO}	JTAG
7	PADD[14..0]	Output	—	V_{CCIO}	AP
8	PADD[19..15]	Output	—	V_{CCIO}	AP
6	PADD[23..20]	Output	—	V_{CCIO}	AP
1	nRESET	Output	—	V_{CCIO}	AP
6	nAVD	Output	—	V_{CCIO}	AP
6	nOE	Output	—	V_{CCIO}	AP
6	nWE	Output	—	V_{CCIO}	AP
5	DEV_OE	Input	—	V_{CCIO}	Optional, AP

Table 8–19. Configuration Pin Summary for Cyclone IV E Devices (Part 3 of 3)

Bank	Description	Input/Output	Dedicated	Powered By	Configuration Mode
5	DEV_CLRn	Input	—	V_{CCIO}	Optional, AP

Notes to Table 8–19:

(1) To tri-state AS configuration pins in the AS configuration scheme, turn-on the **Enable input tri-state on active configuration pins in user mode** option from the **Device and Pin Options** dialog box. This tri-states DCLK, nCSO, Data[0], and Data[1]/ASDO pins. Dual-purpose pins settings for these pins are ignored. To set these pins to different settings, turn off the **Enable input tri-state on active configuration pins in user mode** option and set the desired setting from the Dual-purpose Pins Setting menu.

(2) To tri-state AP configuration pins in the AP configuration scheme, turn-on the **Enable input tri-state on active configuration pins in user mode** option from the **Device and Pin Options** dialog box. This tri-states DCLK, Data[0..15], FLASH_nCE, and other AP pins. Dual-purpose pins settings for these pins are ignored. To set these pins to different settings, turn off the **Enable input tri-state on active configuration pins in user mode** option and set the desired setting from the Dual-purpose Pins Setting menu.

(3) The CRC_ERROR pin is not available in Cyclone IV E devices with 1.0-V core voltage.

(4) The CRC_ERROR pin is a dedicated open-drain output or an optional user I/O pin. Active high signal indicates that the error detection circuit has detected errors in the configuration SRAM bits. This pin is optional and is used when the CRC error detection circuit is enabled in the Quartus II software from the **Error Detection CRC** tab of the **Device and Pin Options** dialog box. When using this pin, connect it to an external 10-kΩ pull-up resistor to an acceptable voltage that satisfies the input voltage of the receiving device.

Table 8–20 describes the dedicated configuration pins. You must properly connect these pins on your board for successful configuration. You may not need some of these pins for your configuration schemes.

Table 8–20. Dedicated Configuration Pins on the Cyclone IV Device (Part 1 of 4)

Pin Name	User Mode	Configuration Scheme	Pin Type	Description
MSEL	N/A	All	Input	Configuration input that sets the Cyclone IV device configuration scheme. You must hardwire these pins to V_{CCA} or GND. The MSEL pins have internal 9-kΩ pull-down resistors that are always active.
nCONFIG	N/A	All	Input	Configuration control input. Pulling this pin low with external circuitry during user mode causes the Cyclone IV device to lose its configuration data, enter a reset state, and tri-state all I/O pins. Returning this pin to a logic-high level starts a reconfiguration.
nSTATUS	N/A	All	Bidirectional open-drain	The Cyclone IV device drives nSTATUS low immediately after power-up and releases it after the POR time. ■ Status output—if an error occurs during configuration, nSTATUS is pulled low by the target device. ■ Status input—if an external source (for example, another Cyclone IV device) drives the nSTATUS pin low during configuration or initialization, the target device enters an error state. Driving nSTATUS low after configuration and initialization does not affect the configured device. If you use a configuration device, driving nSTATUS low causes the configuration device to attempt to configure the device, but because the device ignores transitions on nSTATUS in user mode, the device does not reconfigure. To start a reconfiguration, you must pull nCONFIG low.

Chapter Revision Dates

The chapters in this document, Cyclone IV Device Handbook, were revised on the following dates. Where chapters or groups of chapters are available separately, part numbers are listed.

Chapter 1. Cyclone IV Transceivers Architecture
Revised: *February 2015*
Part Number: *CYIV-52001-3.7*

Chapter 2. Cyclone IV Reset Control and Power Down
Revised: *September 2014*
Part Number: *CYIV-52002-1.4*

Chapter 3. Cyclone IV Dynamic Reconfiguration
Revised: *November 2011*
Part Number: *CYIV-52003-2.1*

Byte Deserializer

The byte deserializer halves the FPGA fabric-transceiver interface frequency while doubles the parallel data width to the FPGA fabric.

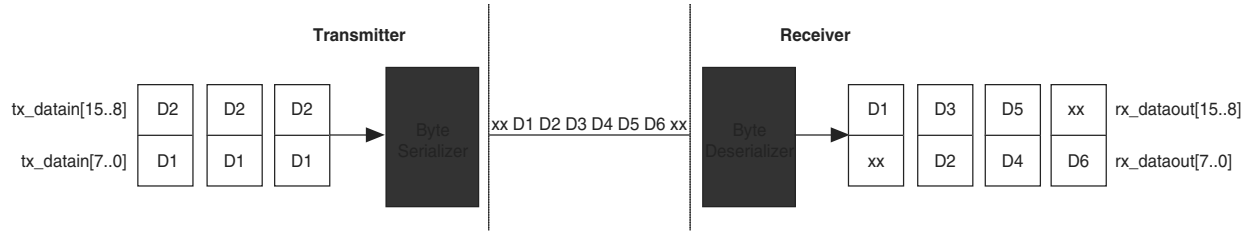
For example, when operating an EP4CGX150 receiver channel at 3.125 Gbps with deserialization factor of 10, the receiver PCS datapath runs at 312.5 MHz. The byte deserializer converts the 10-bit data at 312.5 MHz into 20-bit data at 156.25 MHz before forwarding the data to the FPGA fabric.

Byte Ordering

In the 16- or 20-bit FPGA fabric-transceiver interface, the byte deserializer receives one data byte (8 or 10 bits) and deserializes it into two data bytes (16 or 20 bits). Depending on when the receiver PCS logic comes out of reset, the byte ordering at the output of the byte deserializer may not match the original byte ordering of the transmitted data. The byte misalignment resulting from byte deserialization is unpredictable because it depends on which byte is being received by the byte deserializer when it comes out of reset.

Figure 1–23 shows a scenario where the most significant byte and the least significant byte of the two-byte transmitter data appears straddled across two word boundaries after the data is deserialized at the receiver.

Figure 1–23. Example of Byte Deserializer at the Receiver



The byte ordering block restores the proper byte ordering by performing the following actions:

- Look for the user-programmed byte ordering pattern in the byte-deserialized data
- Inserts a user-programmed pad byte if the user-programmed byte ordering pattern is found in the most significant byte position

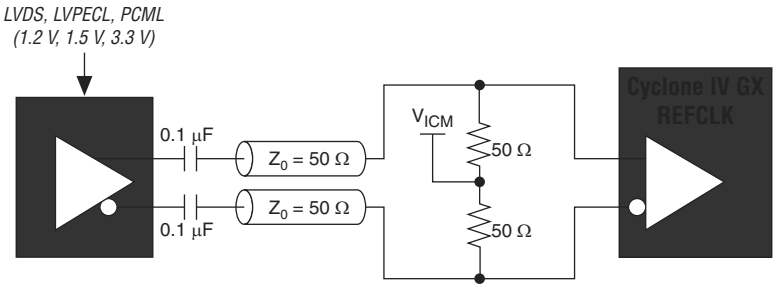
You must select a byte ordering pattern that you know appears at the least significant byte position of the parallel transmitter data.

The byte ordering block is supported in the following receiver configurations:

- 16-bit FPGA fabric-transceiver interface, 8B/10B disabled, and the word aligner in manual alignment mode. Program a custom 8-bit byte ordering pattern and 8-bit pad byte.
- 16-bit FPGA fabric-transceiver interface, 8B/10B enabled, and the word aligner in automatic synchronization state machine mode. Program a custom 9-bit byte ordering pattern and 9-bit pad byte. The MSB of the 9-bit byte ordering pattern and pad byte represents the control identifier of the 8B/10B decoded data.

Figure 1–27 shows an example of the termination scheme for AC-coupled connections for REFCLK pins.

Figure 1–27. AC-Coupled Termination Scheme for a Reference Clock

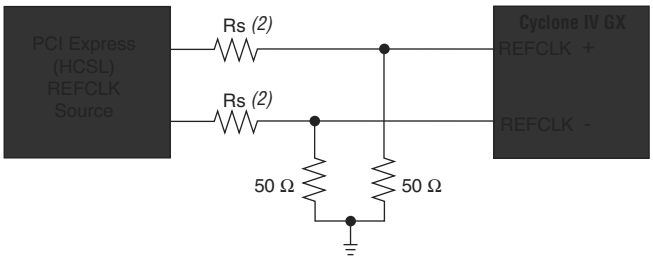


Note to Figure 1–27:

(1) For more information about the V_{ICM} value, refer to the *Cyclone IV Device Datasheet* chapter.

Figure 1–28 shows an example termination scheme for the REFCLK pin when configured as a **HCSL** input.

Figure 1–28. Termination Scheme for a Reference Clock When Configured as HCSL (1)



Notes to Figure 1–28:

(1) No biasing is required if the reference clock signals are generated from a clock source that conforms to the PCIe specification.

(2) Select values as recommended by the PCIe clock source vendor.

Transceiver Channel Datapath Clocking

Channel datapath clocking varies with channel configuration options and PCS configurations. This section describes the clock distribution from the left PLLs for transceiver channels and the datapath clocking in various supported configurations.

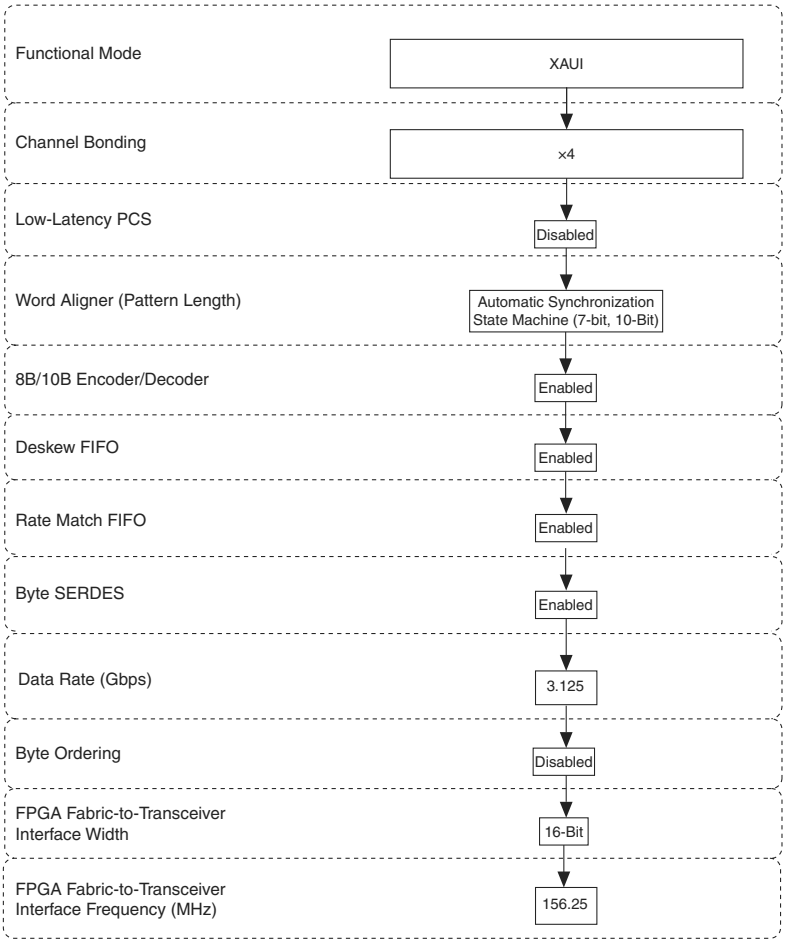
Table 1–7 lists the clocks generated by the PLLs for transceiver datapath.

Table 1–7. PLL Clocks for Transceiver Datapath

Clock	Usage
CDR clocks	Receiver CDR unit
High-speed clock	Transmitter serializer block in PMA
Low-speed clock	Transmitter PCS blocks Receiver PCS blocks when rate match FIFO enabled

Figure 1–64 shows the transceiver configuration in XAUI mode.

Figure 1–64. Transceiver Configuration in XAUI Mode



XGMII and PCS Code Conversions

In XAUI mode, the 8B/10B encoder in the transmitter datapath maps various 8-bit XGMII codes to 10-bit PCS code groups as listed in Table 1–21.

Table 1–21. XGMII Character to PCS Code Groups Mapping (Part 1 of 2)

XGMII TXC (1)	XGMII TXD (2), (3)	PCS Code Group	Description
0	00 through FF	Dxx,y	Normal data transmission
1	07	K28.0, K28.3, or K28.5	Idle in ||I||
1	07	K28.5	Idle in ||T||
1	9C	K28.4	Sequence
1	FB	K27.7	Start
1	FD	K29.7	Terminate
1	FE	K30.7	Error

Clock Rate Compensation

In XAUI mode, the rate match FIFO compensates up to ±100 ppm (200 ppm total) difference between the upstream transmitter and the local receiver reference clock. The XAUI protocol requires the transmitter to send /R/ (/K28.0/) code groups simultaneously on all four lanes (denoted as ||R|| column) during inter-packet gaps, adhering to rules listed in the IEEE P802.3ae specification.

The rate match operation begins after `rx_syncstatus` and `rx_channelaligned` are asserted. The `rx_syncstatus` signal is from the word aligner, indicating that synchronization is acquired on all four channels, while `rx_channelaligned` signal is from the deskew FIFO, indicating channel alignment.

The rate match FIFO looks for the ||R|| column (simultaneous /R/ code groups on all four channels) and deletes or inserts ||R|| columns to prevent the rate match FIFO from overflowing or under running. The rate match FIFO can insert or delete as many ||R|| columns as necessary to perform the rate match operation.

The `rx_rmfifodatadeleted` and `rx_rmfifodatainserted` flags that indicate rate match FIFO deletion and insertion events, respectively, are forwarded to the FPGA fabric. If an ||R|| column is deleted, the `rx_rmfifodeleted` flag from each of the four channels goes high for one clock cycle per deleted ||R|| column. If an ||R|| column is inserted, the `rx_rmfifoinserted` flag from each of the four channels goes high for one clock cycle per inserted ||R|| column.

☞ The rate match FIFO does not insert or delete code groups automatically to overcome FIFO empty or full conditions. In this case, the rate match FIFO asserts the `rx_rmfifofull` and `rx_rmfifoempty` flags for at least three recovered clock cycles to indicate rate match FIFO full and empty conditions, respectively. You must then assert the `rx_digitalreset` signal to reset the receiver PCS blocks.

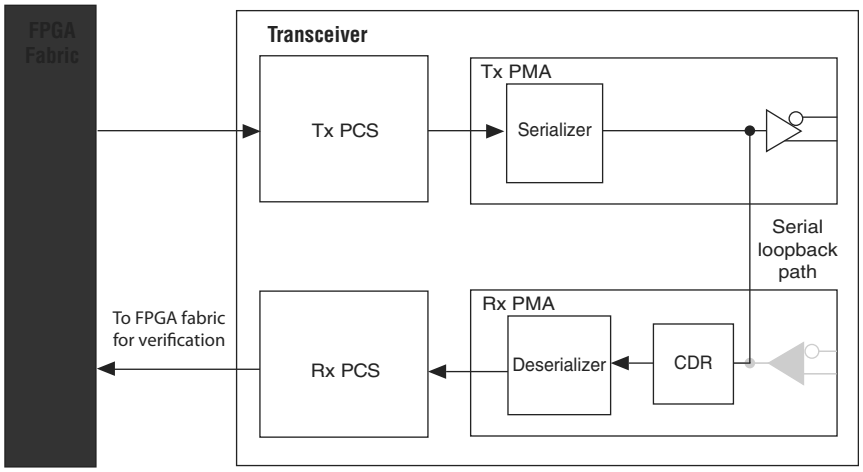
Deterministic Latency Mode

Deterministic Latency mode provides the transceiver configuration that allows no latency uncertainty in the datapath and features to strictly control latency variation. This mode supports non-bonded (×1) and bonded (×4) channel configurations, and is typically used to support CPRI and OBSAI protocols that require accurate delay measurements along the datapath. The Cyclone IV GX transceivers configured in Deterministic Latency mode provides the following features:

- registered mode phase compensation FIFO
- receive bit-slip indication
- transmit bit-slip control
- PLL PFD feedback

Serial loopback mode can only be dynamically enabled or disabled during user mode by performing a dynamic channel reconfiguration.

Figure 1–71. Serial Loopback Path (1)



Note to Figure 1–71:

(1) Grayed-Out Blocks are Not Active in this mode.

Reverse Serial Loopback

The reverse serial loopback mode is available for all functional modes except for XAUI mode. The two reverse serial loopback options from the receiver to the transmitter are:

- Pre-CDR mode where data received through the RX input buffer is looped back to the TX output buffer using the **Reverse serial loopback (pre-CDR)** option
- Post-CDR mode where retimed data through the receiver CDR from the RX input buffer is looped back to the TX output buffer using the **Reverse serial loopback** option

The received data is also available to the FPGA logic. In the transmitter channel, only the transmitter buffer is active.

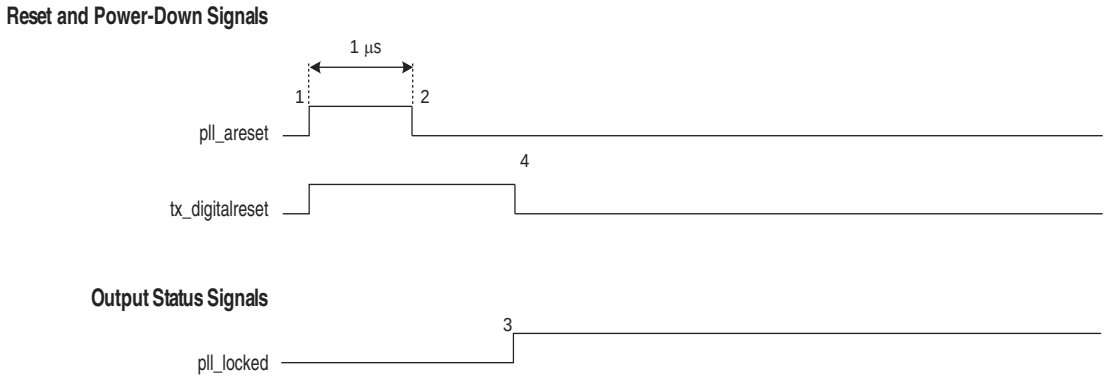
The transmitter pre-emphasis feature is not available in reverse serial loopback (pre-CDR) mode.

Reverse serial loopback modes can only be dynamically enabled or disabled during user mode by performing a dynamic channel reconfiguration.

Transmitter Only Channel

This configuration contains only a transmitter channel. If you create a **Transmitter Only** instance in the ALTGX MegaWizard Plug-In Manager in Basic ×4 functional mode, use the reset sequence shown in Figure 2–3.

Figure 2–3. Sample Reset Sequence for Bonded and Non-Bonded Configuration Transmitter Only Channels

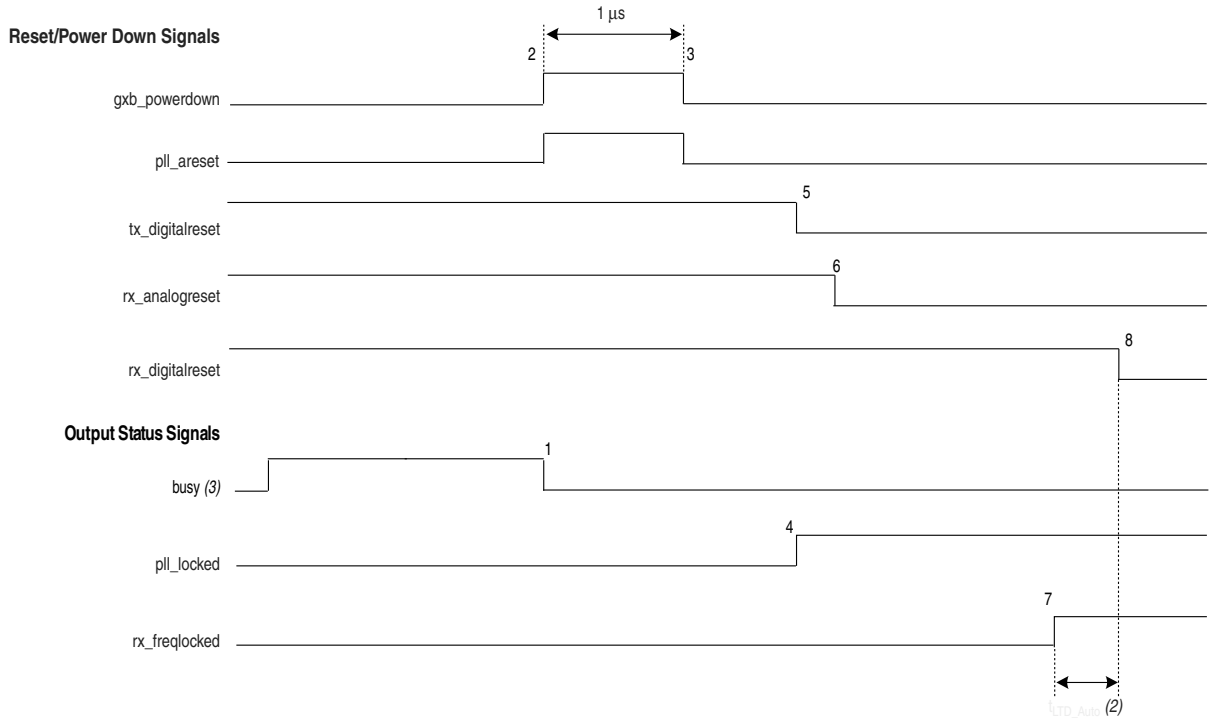


As shown in Figure 2–3, perform the following reset procedure for the **Transmitter Only** channel configuration:

1. After power up, assert `pll_areset` for a minimum period of 1 µs (the time between markers 1 and 2).
2. Keep the `tx_digitalreset` signal asserted during this time period. After you de-assert the `pll_areset` signal, the multipurpose PLL starts locking to the transmitter input reference clock.
3. When the multipurpose PLL locks, as indicated by the `pll_locked` signal going high (marker 3), de-assert the `tx_digitalreset` signal (marker 4). At this point, the transmitter is ready for transmitting data.

The deassertion of the busy signal indicates proper completion of the offset cancellation process on the receiver channel.

Figure 2–13. Sample Reset Sequence of a Receiver and Transmitter Channels-Receiver CDR in Automatic Lock Mode with the Optional gxb_powerdown Signal (1)



Notes to Figure 2–13:

(1) The gxb_powerdown signal must not be asserted during the offset cancellation sequence.

(2) For t_{LTD_Auto} duration, refer to the *Cyclone IV Device Datasheet* chapter.

(3) The busy signal is asserted and deasserted only during initial power up when offset cancellation occurs. In subsequent reset sequences, the busy signal is asserted and deasserted only if there is a read or write operation to the ALTGX_RECONFIG megafunction.

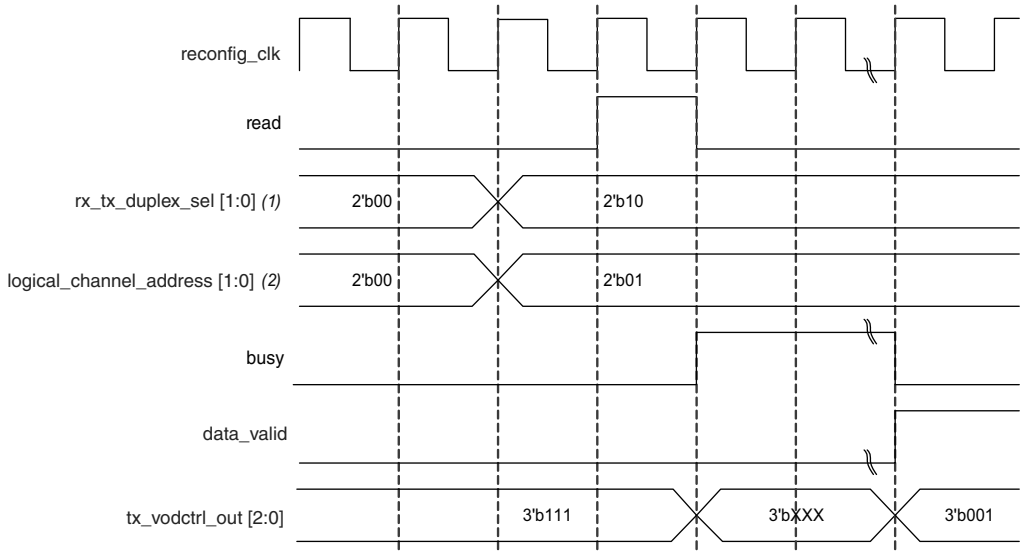
Simulation Requirements

The following are simulation requirements:

- The gxb_powerdown port is optional. In simulation, if the gxb_powerdown port is not instantiated, you must assert the tx_digitalreset, rx_digitalreset, and rx_analogreset signals appropriately for correct simulation behavior.
- If the gxb_powerdown port is instantiated, and the other reset signals are not used, you must assert the gxb_powerdown signal for at least 1 µs for correct simulation behavior.
- You can deassert the rx_digitalreset signal immediately after the rx_freqlocked signal goes high to reduce the simulation run time. It is not necessary to wait for t_{LTD_Auto} (as suggested in the actual reset sequence).
- The busy signal is deasserted after about 20 parallel reconfig_clk clock cycles in order to reduce simulation run time. For silicon behavior in hardware, you can follow the reset sequences described in the previous pages.

Figure 3–5 shows the read transaction waveform for Method 1.

Figure 3–5. Read Transaction Waveform—Use 'logical_channel_address port' Option



Notes to Figure 3–5:

(1) In this waveform example, you want to read from only the transmitter portion of the channel.

(2) In this waveform example, the number of channels connected to the dynamic reconfiguration controller is four. Therefore, the `logical_channel_address` port is 2 bits wide.

☞ Simultaneous write and read transactions are not allowed.

Method 2: Writing the Same Control Signals to Control All the Transceiver Channels

This method does not require the `logical_channel_address` port. The PMA controls of all the transceiver channels connected to the ALTGX_RECONFIG instance are reconfigured.

The **Use the same control signal for all the channels** option is available on the **Analog controls** tab of the ALTGX_RECONFIG MegaWizard Plug-In Manager. If you enable this option, the width of the PMA control ports are fixed as follows:

PMA Control Ports Used in a Write Transaction

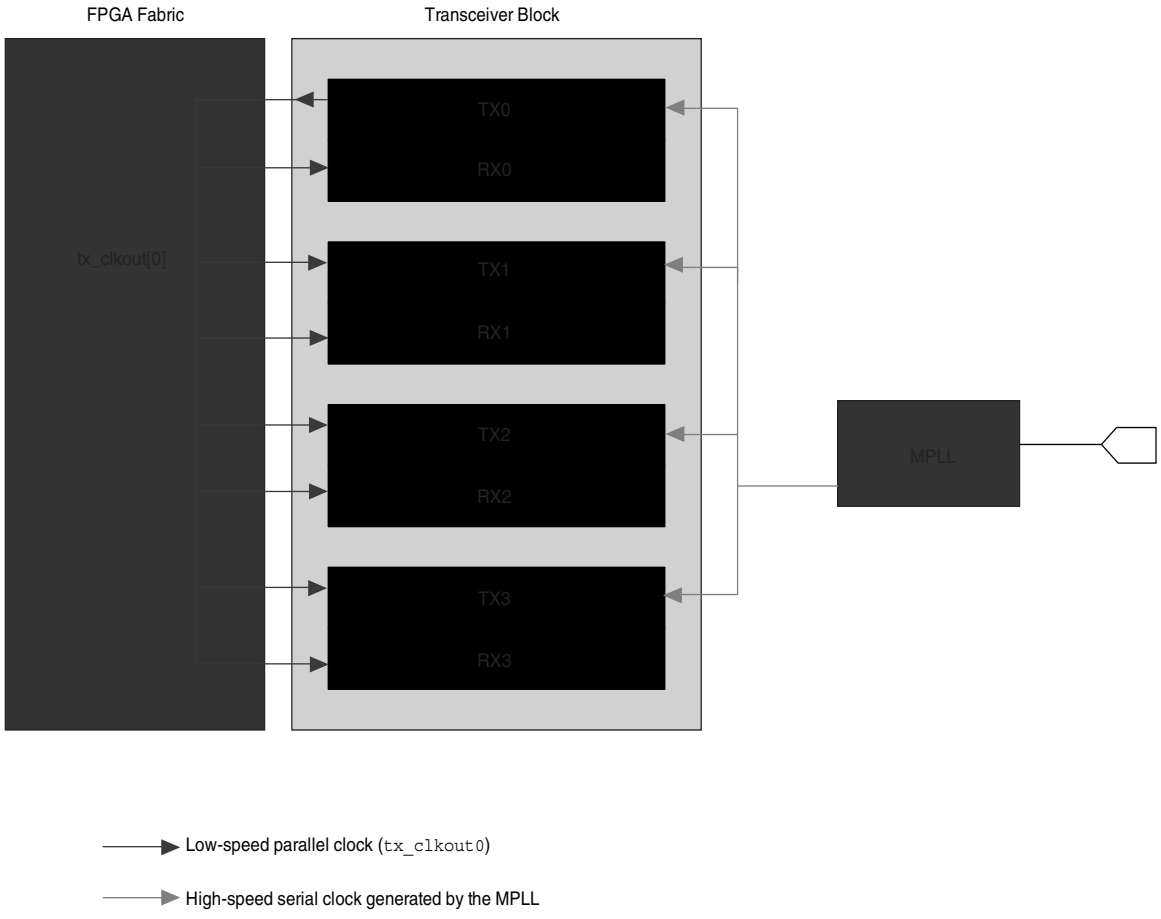
- `tx_vodctrl` is fixed to 3 bits
- `tx_preemp` is fixed to 5 bits
- `rx_eqdcgain` is fixed to 2 bits
- `rx_eqctrl` is fixed to 4 bits

Option 1: Share a Single Transmitter Core Clock Between Receivers

- Enable this option if you want `tx_clkout` of the first channel (channel 0) of the transceiver block to provide the read clock to the Receive Phase Compensation FIFOs of the remaining receiver channels in the transceiver block.
- This option is typically enabled when all the channels of a transceiver block are in a Basic or Protocol configuration with rate matching enabled and are reconfigured to another Basic or Protocol configuration with rate matching enabled.

Figure 3–13 shows the sharing of channel 0's `tx_clkout` between all four channels of a transceiver block.

Figure 3–13. Option 1 for Receiver Core Clocking (Channel Reconfiguration Mode)



Cyclone IV E industrial devices I7 are offered with extended operating temperature range.

Absolute Maximum Ratings

Absolute maximum ratings define the maximum operating conditions for Cyclone IV devices. The values are based on experiments conducted with the device and theoretical modeling of breakdown and damage mechanisms. The functional operation of the device is not implied at these conditions. Table 1–1 lists the absolute maximum ratings for Cyclone IV devices.

CAUTION

Conditions beyond those listed in Table 1–1 cause permanent damage to the device. Additionally, device operation at the absolute maximum ratings for extended periods of time have adverse effects on the device.

Table 1–1. Absolute Maximum Ratings for Cyclone IV Devices *(1)*

Symbol	Parameter	Min	Max	Unit
V_{CCINT}	Core voltage, PCI Express® (PCIe®) hard IP block, and transceiver physical coding sublayer (PCS) power supply	–0.5	1.8	V
V_{CCA}	Phase-locked loop (PLL) analog power supply	–0.5	3.75	V
V_{CCD_PLL}	PLL digital power supply	–0.5	1.8	V
V_{CCIO}	I/O banks power supply	–0.5	3.75	V
V_{CC_CLKIN}	Differential clock input pins power supply	–0.5	4.5	V
V_{CCH_GXB}	Transceiver output buffer power supply	–0.5	3.75	V
V_{CCA_GXB}	Transceiver physical medium attachment (PMA) and auxiliary power supply	–0.5	3.75	V
V_{CCL_GXB}	Transceiver PMA and auxiliary power supply	–0.5	1.8	V
V_I	DC input voltage	–0.5	4.2	V
I_{OUT}	DC output current, per pin	–25	40	mA
T_{STG}	Storage temperature	–65	150	°C
T_J	Operating junction temperature	–40	125	°C

Note to Table 1–1:

(1) Supply voltage specifications apply to voltage readings taken at the device pins with respect to ground, not at the power supply.

Maximum Allowed Overshoot or Undershoot Voltage

During transitions, input signals may overshoot to the voltage shown in Table 1–2 and undershoot to –2.0 V for a magnitude of currents less than 100 mA and for periods shorter than 20 ns. Table 1–2 lists the maximum allowed input overshoot voltage and the duration of the overshoot voltage as a percentage over the lifetime of the device. The maximum allowed overshoot duration is specified as a percentage of high-time over the lifetime of the device.

Table 1–21. Transceiver Specification for Cyclone IV GX Devices (Part 4 of 4)

Symbol/ Description	Conditions	C6			C7, I7			C8			Unit
		Min	Typ	Max	Min	Typ	Max	Min	Typ	Max	
PLD-Transceiver Interface											
Interface speed (F324 and smaller package)	—	25	—	125	25	—	125	25	—	125	MHz
Interface speed (F484 and larger package)	—	25	—	156.25	25	—	156.25	25	—	156.25	MHz
Digital reset pulse width	—	Minimum is 2 parallel clock cycles									

Notes to Table 1–21:

(1) This specification is valid for transmitter output jitter specification with a maximum total jitter value of 112 ps, typically for 3.125 Gbps SRIO and XAUI protocols.

(2) The minimum `reconfig_clk` frequency is 2.5 MHz if the transceiver channel is configured in **Transmitter Only** mode. The minimum `reconfig_clk` frequency is 37.5 MHz if the transceiver channel is configured in **Receiver Only** or **Receiver and Transmitter** mode.

(3) The device cannot tolerate prolonged operation at this absolute maximum.

(4) The rate matcher supports only up to ±300 parts per million (ppm).

(5) Supported for the F169 and F324 device packages only.

(6) Supported for the F484, F672, and F896 device packages only. Pending device characterization.

(7) To support CDR ppm tolerance greater than ±300 ppm, implement ppm detector in user logic and configure CDR to Manual Lock Mode.

(8) Asynchronous spread-spectrum clocking is not supported.

(9) For the EP4CGX30 (F484 package only), EP4CGX50, and EP4CGX75 devices, the CDR ppl tolerance is ±200 ppm.

(10) Time taken until `pll_locked` goes high after `pll_powerdown` deasserts.

(11) Time that the CDR must be kept in lock-to-reference mode after `rx_analogreset` deasserts and before `rx_locktodata` is asserted in manual mode.

(12) Time taken to recover valid data after the `rx_locktodata` signal is asserted in manual mode (Figure 1–2), or after `rx_freqlocked` signal goes high in automatic mode (Figure 1–3).

(13) Time taken to recover valid data after the `rx_locktodata` signal is asserted in manual mode.

(14) Time taken to recover valid data after the `rx_freqlocked` signal goes high in automatic mode.

(15) To support data rates lower than the minimum specification through oversampling, use the CDR in LTR mode only.

Document Revision History

Table 1–47 lists the revision history for this chapter.

Table 1–47. Document Revision History

Date	Version	Changes
December 2016	2.1	Added note to Table 1–9 and Table 1–10.
March 2016	2.0	Updated note (5) in Table 1–21 to remove support for the N148 package.
October 2014	1.9	Updated maximum value for V_{CCD_PLL} in Table 1–1. Removed extended temperature note in Table 1–3.
December 2013	1.8	Updated Table 1–21 by adding Note (15).
May 2013	1.7	Updated Table 1–15 by adding Note (4).
October 2012	1.6	■ Updated the maximum value for V_I, V_{CCD_PLL}, V_{CCIO}, V_{CC_CLKIN}, V_{CCH_GXB}, and V_{CCA_GXB} Table 1–1. ■ Updated Table 1–11 and Table 1–22. ■ Updated Table 1–21 to include peak-to-peak differential input voltage for the Cyclone IV GX transceiver input reference clock. ■ Updated Table 1–29 to include the typical DCLK value. ■ Updated the minimum f_{HSCLK} value in Table 1–31, Table 1–32, Table 1–33, Table 1–34, and Table 1–35.
November 2011	1.5	■ Updated “Maximum Allowed Overshoot or Undershoot Voltage”, “Operating Conditions”, and “PLL Specifications” sections. ■ Updated Table 1–2, Table 1–3, Table 1–4, Table 1–5, Table 1–8, Table 1–9, Table 1–15, Table 1–18, Table 1–19, and Table 1–21. ■ Updated Figure 1–1.
December 2010	1.4	■ Updated for the Quartus II software version 10.1 release. ■ Updated Table 1–21 and Table 1–25. ■ Minor text edits.
July 2010	1.3	Updated for the Quartus II software version 10.0 release: ■ Updated Table 1–3, Table 1–4, Table 1–21, Table 1–25, Table 1–28, Table 1–30, Table 1–40, Table 1–41, Table 1–42, Table 1–43, Table 1–44, and Table 1–45. ■ Updated Figure 1–2 and Figure 1–3. ■ Removed SW Requirement and TCCS for Cyclone IV Devices tables. ■ Minor text edits.
March 2010	1.2	Updated to include automotive devices: ■ Updated the “Operating Conditions” and “PLL Specifications” sections. ■ Updated Table 1–1, Table 1–8, Table 1–9, Table 1–21, Table 1–26, Table 1–27, Table 1–31, Table 1–32, Table 1–33, Table 1–34, Table 1–35, Table 1–36, Table 1–37, Table 1–38, Table 1–40, Table 1–42, and Table 1–43. ■ Added Table 1–5 to include ESD for Cyclone IV devices GPIOs and HSSI I/Os. ■ Added Table 1–44 and Table 1–45 to include IOE programmable delay for Cyclone IV E 1.2 V core voltage devices. ■ Minor text edits.